

# **Reference Specification**

Type EA /Safety Standard Certified Resin Molding SMD Type Ceramic Capacitors for General Purpose

Product specifications in this catalog are as of Jun. 2023, and are subject to change or obsolescence without notice. Please consult the approval sheet before ordering.Please read rating and Cautions first.

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## **1. OPERATING VOLTAGE**

1) Do not apply a voltage to a safety standard certified product that exceeds the rated voltage as called out in the specifications. Applied voltage between the terminals of a safety standard certified product shall be less than or equal to the rated voltage (+10 %). When a safety standard certified product is used as a DC voltage product, the AC rated voltage value becomes the DC rated voltage value.

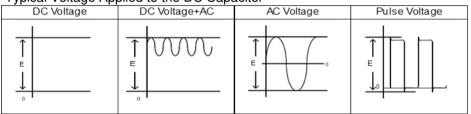
(Example:AC250 V (r.m.s.) rated product can be used as DC250 V (+10 %) rated product.)

If both AC rated voltage and DC rated voltage are specified, apply the voltage lower than the respective rated voltage.

1-1) When a safety standard certified product is used in a circuit connected to a commercial power supply, ensure that the applied commercial power supply voltage including fluctuation should be less than 10 % above its rated voltage.

1-2) When using a safety standard certified product as a DC rated product in circuits other than those connected to a commercial power supply.

When AC voltage is superimposed on DC voltage, the zero-to-peak voltage shall not exceed the rated DC voltage. When AC voltage or pulse voltage is applied, the peak-to-peak voltage shall not exceed the rated DC voltage.



Typical Voltage Applied to the DC Capacitor

(E: Maximum possible applied voltage.)

2) Abnormal voltages (surge voltage, static electricity, pulse voltage, etc.) shall not exceed the rated DC voltage.

## 2. OPERATING TEMPERATURE AND SELF-GENERATED HEAT

Keep the surface temperature of a capacitor below the upper limit of its rated operating temperature range. Be sure to take into account the heat generated by the capacitor itself.

When the capacitor is used in a high-frequency current, pulse current or the like, it may have the selfgenerated heat due to dielectric-loss. Applied voltage should be the load such as self-generated heat is within 20 °C <u>on the condition of atmosphere temperature 25 °C.</u> When measuring, use a thermocouple of small thermal capacity-K of  $\Phi 0.1$  mm and be in the condition where capacitor is not affected by radiant heat of other components and wind of surroundings. Excessive heat may lead to deterioration of the capacitor's characteristics and reliability. (Never attempt to perform measurement with the cooling fan running. Otherwise, accurate measurement cannot be ensured.)

## 3. TEST CONDITION FOR WITHSTANDING VOLTAGE

#### 1) TEST EQUIPMENT

Test equipment for AC withstanding voltage should be used with the performance of the wave similar to 50/60 Hz sine wave.

If the distorted sine wave or over load exceeding the specified voltage value is applied, the defective may be caused.

#### 2) VOLTAGE APPLIED METHOD

When the withstanding voltage is applied, capacitor's lead or terminal should be firmly connected to the out-put of the withstanding voltage test equipment, and then the voltage should be raised from near zero to the test voltage.

If the test voltage without the raise from near zero voltage would be applied directly to capacitor, test voltage should be applied with the \*zero cross. At the end of the test time, the test voltage should be reduced to near zero, and then capacitor's lead or terminal should be taken off the out-put of the withstanding voltage test equipment.

If the test voltage without the raise from near zero voltage would be applied directly to capacitor, the surge voltage may arise, and therefore, the defective may be caused.

\*ZERO CROSS is the point where voltage sine wave pass 0 V.

- See the right figure -

## 4. FAIL-SAFE

When capacitor would be broken, failure may result in a short circuit. Be sure to provide an appropriate fail-safe function like a fuse on your product if failure would follow an electric shock, fire or fume.

## 5. VIBRATION AND IMPACT

Do not expose a capacitor or its leads to excessive shock or vibration during use.

## 6. SOLDERING

#### 6-1.Reflow Soldering

When soldering capacitor, it should be performed in following conditions.

Soldering temperature	: 230 to 260 °C
Soldering time	: 10 to 30 s
Preheating temperature	:170 °C max.

## 6-2.Flow Soldering

When soldering capacitor, it should be performed in following conditions.

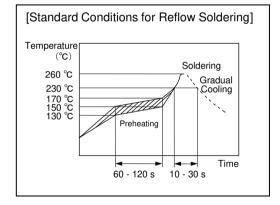
Soldering temperature	: 260 °C max.
Soldering time	: 5 s max.
Preheating temperature	:120 °C max.
Preheating time	: 60 s max.

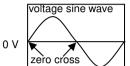
6-3.Soldering Iron

When soldering this product to a PCB/PWB, do not exceed the solder heat resistance specification of the capacitor. Subjecting this product to excessive heating could melt the internal junction solder and may result in thermal shocks that can crack the ceramic element.

When soldering capacitor with a soldering iron, it should be performed in following conditions.

Temperature of iron-tip	: 400 °C max.
Soldering iron wattage	: 50 W max.
Soldering time	: 3.5 s max.





## 7. BONDING, RESIN MOLDING AND COATING

Before bonding, molding or coating this product, verify that these processes do not affect the quality of capacitor by testing the performance of the bonded, molded or coated product in the intended equipment.

In case of the amount of applications, dryness / hardening conditions of adhesives and molding resins containing organic solvents (ethyl acetate, methyl ethyl ketone, toluene, etc.) are unsuitable, the outer coating resin of a capacitor is damaged by the organic solvents and it may result, worst case, in a short circuit.

The variation in thickness of adhesive, molding resin or coating may cause a outer coating resin cracking and/or ceramic element cracking of a capacitor in a temperature cycling.

## 8. OPERATING AND STORAGE ENVIRONMENT

The insulation coating of capacitors does not form a perfect seal; therefore, do not use or store capacitors in a corrosive atmosphere, especially where chloride gas, sulfide gas, acid, alkali, salt or the like are present. And avoid exposure to moisture. Before cleaning, bonding, or molding this product, verify that these processes do not affect product quality by testing the performance of a cleaned, bonded or molded product in the intended equipment.

This one is MSL 3 product. So, in order to avoid the absorption of moisture, capacitors are packed in moisture-proof envelope.

Store the capacitors in the following conditions at all times, and use within 6 months after delivered.

Temperature : 10 to 30 °C

Humidity : 60 % max.

Solder the enclosed capacitors within 168 hours after opening the moisture-proof package. After opening, store the capacitors in moisture-proof package with a desiccant and HIC card and keep the above condition.

In case the storage period has been exceeded 6 months or the indicator color of a enclosed HIC card has changed when the package has been opened, perform baking (60  $^{\circ}C \times 168$  hr) before soldering.

#### 9. LIMITATION OF APPLICATIONS

Please contact us before using our products for the applications listed below which require especially high reliability for the prevention of defects which might directly cause damage to the third party's life, body or property.

- 1. Aircraft equipment
- 2. Aerospace equipment
- 3. Undersea equipment
- 4. Power plant control equipment
- 5. Medical equipment
- 6. Transportation equipment (automotives, trains, ships, etc.)
- 7. Traffic signal equipment
- 8. Disaster prevention / crime prevention equipment
- 9. Data-processing equipment exerting influence on public
- 10. Application of similar complexity and/or reliability requirements to the applications listed in the above.

## NOTICE

## 1. CLEANING (ULTRASONIC CLEANING)

To perform ultrasonic cleaning, observe the following conditions. Rinse bath capacity : Output of 20 watts per liter or less.

Rinsing time : 5 min maximum.

Do not vibrate the PCB/PWB directly.

Excessive ultrasonic cleaning may lead to fatigue destruction of the terminals.

## 2. CAPACITANCE CHANGE OF CAPACITORS

## Class 1 capacitors

Capacitance might change a little depending on a surrounding temperature or an applied voltage. Please contact us if you use for the strict time constant circuit.

Class 2 capacitors

Class 2 capacitors like temperature characteristic B, E and F have an aging characteristic, whereby the capacitor continually decreases its capacitance slightly if the capacitor leaves for a long time. Moreover, capacitance might change greatly depending on a surrounding temperature or an applied voltage. So, it is not likely to be able to use for the time constant circuit. Please contact us if you need a detail information.

## 3. PERFORMANCE CHECK BY EQUIPMENT

Before using a capacitor, check that there is no problem in the equipment's performance and the specifications.

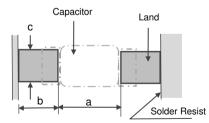
Generally speaking, Class 2 ceramic capacitors have voltage dependence characteristics and temperature dependence characteristics in capacitance. So, the capacitance value may change depending on the operating condition in a equipment. Therefore, be sure to confirm the apparatus performance of receiving influence in a capacitance value change of a capacitor, such as leakage current and noise suppression characteristic.

Moreover, check the surge-proof ability of a capacitor in the equipment, if needed, because the surge voltage may exceed specific value by the inductance of the circuit.

## 4. Land Dimensions

The recommandable land dimensions for reflow soldering are follows.

Regarding the "a" dimension, to ensure the creepage distance required by the safety standard applys to your equipment.



Dimension	а	b	С
8.0 × 6.0	8.0	2.2	3.6

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- 1. Please make sure that your product has been evaluated in view of your specifications with our product being mounted to your product.
- 2. You are requested not to use our product deviating from this specification.

#### 1.Application

This specification is applied to Safety Standard Certified Resin Molding SMD Type Ceramic Capacitors Type EA used for General Electric equipment.

The safety standard certification is obtained by Class X1, Y1.

Do not use these products in any automotive power train or safety equipment including battery charger for electric vehicles and plug-in hybrids.

Approval standard and certified number

	Standard number	*Certified number	Rated voltage
UL/cUL	UL60384-14/CSA E60384-14	E37921	
ENEC (SEMKO)	EN60384-14	SE-ENEC-2300151	X1: AC440 V(r.m.s.) Y1: AC250 V(r.m.s.)
CQC	IEC60384-14	CQC16001142384	TT. A0230 V(T.III.S.)
KTC	KC60384-14	HU03008-16007	

\*Above Certified number may be changed on account of the revision of standards and the renewal of certification.

#### 2.Rating

2-1.Operating temperature range

-40 ~ 125°C

2-2.Rated Voltage

X1: AC440 V(r.m.s.) Y1: AC250 V(r.m.s.) DC1,000 V

2-3.Part number configuration

ex.)

DK1	E3	EA	152	М	86	R	AH01
Series	Temperature	Certified	Capacitance	Capacitance	Body	Package	Individual
	Characteristics	Туре		Tolerance	Dimension		Specification

#### Series

DK1 denotes resin molding SMD type safety standard recognized ceramic capacitor of class Y1.

#### Temperature Characteristics

Please confirm detailed specification on [Specification and test methods].

Code	Temperature Characteristics
1X	SL
B3	В
E3	E

#### Certified Type

This denotes safety certified type name Type EA.

Capacitance

The first two digits denote significant figures ; the last digit denotes the multiplier of 10 in pF. ex.) In case of  $152\,$  .

 $15 \times 10^2 = 1500 \text{ pF}$ 

#### Capacitance Tolerance

Please refer to [ Part number list ].

Code	Body Dimension
86	8.0 × 6.0 mm
Package	
Code	Package
R	Ф330 mm Reel type
<ul> <li>Individual Specification</li> </ul>	
Murata's control code	
Please refer to Part number	list .
Marking	
Certified type	: EA
Capacitance	: Actual value(under 100 pF)
	3 digit system(100 pF and over)
Rated Voltage	: X1 440~
C C	Y1 250~
Company name code	: 🕑 I 5 (Made in Thailand)
Manufacturing year	: Letter code (The last digit of A.D. year.)
Manufacturing month	: Code
Ŭ	ex.) YEAR MONTH
	20 <u>22</u> 11( <u>N</u> ovember)
	2N *
	*From January to September : "1" to "9",
	October : "O", November : "N", December : "D"
KTC Approval mark	: 🔀
	(Example)
	EA 152
	EA 152 XI 440~ YI 250~
	YI 250~
	🛛 🕑 I 5 2N 📓 🖯

	W 8.0	+/-0.5 L			.3					
	0.75+/-0.3 (10	) typ.)		Ţ				Unit : mm		
					Dime	ension (m	m)		Pack	
Customer Part Number	Murata Part Number	T.C.	Cap. (pF)			L	w	, T max.	Body Dimension	qty. (pcs)
Dł	K11XEA100K86RAH01	SL	10	±10%	11.4±0.5	6.0±0.5	2.5	86	2500	
Dł	K11XEA220K86RAH01	SL	22	±10%	11.4±0.5	6.0±0.5	2.5	86	250	
Dł	K11XEA470K86RAH01	SL	47	±10%	11.4±0.5	6.0±0.5	2.5	86	250	
Dł	K1B3EA101K86RAH01	В	100	±10%	11.4±0.5	6.0±0.5	2.5	86	250	
Dł	K1B3EA221K86RAH01	В	220	±10%	11.4±0.5	6.0±0.5	2.5	86	250	
Dł	K1B3EA331K86RAH01	В	330	±10%	11.4±0.5	6.0±0.5	2.5	86	250	
Dł	K1B3EA471K86RAH01	В	470	±10%	11.4±0.5	6.0±0.5	2.5	86	250	
Dł	K1B3EA681K86RAH01	В	680	±10%	11.4±0.5	6.0±0.5	2.5	86	250	
Dł	K1E3EA102M86RAH01	Е	1000	±20%	11.4±0.5	6.0±0.5	2.5	86	250	
Dł	K1E3EA152M86RAH01	Е	1500	±20%	11.4±0.5	6.0±0.5	2.5	86	250	

5. Sp	ecification and	test methods							
No.		Item	Specification			Test	method		
1	Operating Temperature -40 to 12		-40 to 125 °C						
2	Appearance		No defects or abnormalities	Visual insp	Visual inspection.				
3	Dimensions		Within the specified dimension.			icrometers			
4	Dielectric stre	ngth	No defects or abnormalities.			ot be dama termination	ige when A s for 60 s.	C4,000 V(r	.m.s.) is
5	Insulation Res	sistance (I.R.)	6,000 MΩ or more.	within 60±	The insulation resistance shall be measured with DCS within $60\pm5$ s of charging. The voltage should be applied to the capacitor throug 1 M $\Omega$ .				
6	Capacitance		Within the specified tolerance.	Capacitan	ce/D.F. sha	all be meas	ured at 20	°C with the	frequency
7	Dissipation Fa	actor (D.F.)	DF≦0.025	of 1±0.2 k	Hz and a v	oltage of A	C1±0.2 V(r.	.m.s.).	
8	Capacitance Temperature characteristic       Temp. Coefficient SL: +350 to -1000 ppm/°C (Temp. Range: 20 to 85°C)         Cap. Change B:within ±10 %       E:within +20/-55 % (Temp. Range:-25 to 85 °C)		•Pretreatm Perform th let sit for 2	ient for B, I ie heat trea	E char.	shall be ma 50+0/-10 °C ion.		-	
			Г	Stop	1	2	3	4	5
				Step Temp.(°C)	20±2	-25±2	20±2	4 85±2	20±2
9	Vibration resistance Dissipation Factor (D.F.)		No marked defect. Within the specified tolerance. Pass the item No.7.	<ul> <li>Solder the capacitor to the Test Jig A (glass epoxy board) shown</li> <li>"Complement of test method".</li> <li>The capacitor shall be subjected to a simple harmonic motion having a total amplitude of 1.5mm, the frequency being varied uniformly between the approximate limits of 10 and 55 Hz.</li> <li>The frequency range, from 10 to 55 Hz and return to 10Hz, shall traversed in approximately 1 min.</li> <li>This motion shall be applied for a period of 2 h in each of 3</li> </ul>					
10	Solderability c	of termination	75 % of the terminations are to be soldered .	mutually perpendicular directions (total of 6 h). Immerse the capacitor in the solution of ethanol (JIS K rosin (JIS K 5902) (25 % rosin in weight proportion). Immerse in solder solution for 2±0.5 s. Temp. of solder : 245±5 °C			K 8101) an		
11	Soldering	Appearance	No marked defects.				180 °C for 9	90+30 s.	
	effect (Reflow)	Capacitance change	Within ±10 %	Reflow ten Reflow tim	np. :230 ie :30±1	°C min. (Ma 0 s.	ax. temp. :	260 °C)	
		I.R.	1,000 MΩ or more.			ies : 4 time	-	noasuro	
		Dielectric strength	Pass the item No.4.	<ul> <li>Let sit at *room condition for 24±2 h, then measure.</li> <li>The next reflow porcess should be done after the ten the sample has dropped to room temperature.</li> <li>Pretreatment for B, E char.</li> <li>Capacitor should be stored at 150+0/-10 °C for 1 h, ar AC4,000 V(r.m.s.) 60 s then placed at *room condition before initial measurements.</li> </ul>		nd apply the			
12	2 Adhesive strength of termination		No removal of the terminations or other defects should occur.	in "Comple	ement of Te	est method e in the dire	Jig A (glas ". ection of the 10±1 s poxy Board		oard) showr
* "roc	m condition" T	emperature : 15	to 35 °C, Relative humidity : 45 to 75	%, Atmospheri	c pressure	Glass Ep	oxy Board		

No.		tem	Specification	Test method				
13	Temperature Appearance		No marked defect.	Fix the capacitor to the supporting Test Jig A (glass epoxy board)				
	cycle	change		shown in "Complement of test method". Perform the 5 cycles according to the 4 heat treatments listed to following table.				
		Dissipation Factor (D.F.)	SL : DF≦0.025 B,E: DF≦0.05	Step Temp.(°C) Time(min.)				
		I.R.	3,000 MΩ or more	1 -40±3 30±3				
		Dielectric	Pass the item No.4.	2         Room Temp.         2 to 3           3         125±3         30±3				
		strength		4 Room Temp. 2 to 3				
				Let sit at *room condition for 24±2 h, then measure. • Pretreatment for B, E char. Capacitor should be stored at 150+0/-10 °C for 1 h, and apply the AC4,000 V(r.m.s.) 60 s then placed at *room condition for 24±2 h before initial measurements.				
14	Humidity	Appearance	No marked defect.	Sit the capacitor at 40±2 °C and relative humidity 90 to 95 % for				
	(Steady state)	Capacitance change	Within ±20 %	500+24/-0 h. Remove and let sit for 24±2 h at *room condition, then measure. • Pretreatment for B. E char.				
		Dissipation Factor (D.F.)	SL : DF≦0.025 B,E: DF≦0.05	Capacitor should be stored at $150+0/-10$ °C for 1 h, and apply the AC4,000 V(r.m.s.) 60 s then placed at *room condition for $24\pm 2$ h				
		I.R.	3,000 MΩ or more	before initial measurements.				
		Dielectric strength	Pass the item No.4.					
15	Humidity	Appearance	No marked defect.	Apply the rated voltage at 40±2 °C and relative humidity				
	loading	Capacitance change	Within ±20 %	90 to 95% for 500+24/-0 h. Remove and let sit for 24±2 h at *room condition, then measure. • Pretreatment for B,E char.				
		Dissipation Factor (D.F.)	SL : DF≦0.025 B,E: DF≦0.05	Capacitor should be stored at 150+0/-10 °C for 1 h, and apply the AC4,000 V(r.m.s.) 60 s then placed at *room condition for 24±2 h				
		I.R.	3,000 M $\Omega$ or more	before initial measurements.				
		Dielectric strength	Pass the item No.4.					
16	Life	Appearance	No marked defect.	Impulse Voltage test is performed.				
		Capacitance change	Within ±20 %	Each individual capacitor shall be subjected to a 8 kV Impulse (the voltage value means zero to peak) for 3 times or more. Then the capacitors are applied to life test.				
		I.R.	3,000 MΩ or more					
		Dielectric strength	Pass the item No.4.	Front time (T1) = 1.7 $\mu$ s=1.67T Time to half-value (T2) = 50 $\mu$ s				
				Apply voltage as Table for 1,000 h at 125+2/-0 °C, relative humidit 50 % max.				
			Applied voltage AC550 V(r.m.s.) except that once each hour the voltage is increased to AC1,000 V(r.m.s.) for 0.1 s.					
				Remove and let sit for 24±2 h at *room condition, then measure. • Pretreatment for B, E char. Capacitor should be stored at 150+0/-10 °C for 1 h, and apply the AC4,000 V(r.m.s.) 60 s then placed at *room condition for 24±2 h before initial measurements.				

Reference only

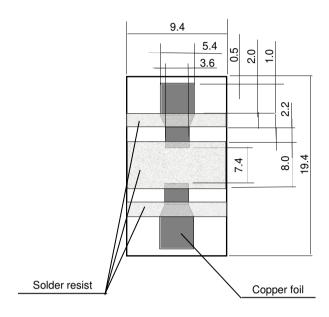
		Reference	oniy
No.	Item	Specification	Test method
17	Passive flammability	The burning time should not be exceeded the time 30 s. The tissue paper should not ignite.	The capacitor under test shall be held in the flame in the position which best promotes burning. Each specimen shall only be exposed once to the flame. Time of exposure to flame : 30 s. Length of flame : 12±1 mm Gas burner : Length 35 mm min. Inside dia : 0.5±0.1 mm Outside dia : 0.9 mm max. Gas : Butane gas purity 95 % min. Approximately 8mm burner
18	Active flammability	The cheese-cloth should not be on fire.	The capacitor shall be individually wrapped in at least one but more than two complete layers of cheesecloth. The capacitor shall be subjected to 20 discharges. The interval between successive discharges shall be 5 s. The UAc shall be maintained for 2 min after the last discharge. I = I = I = I = I = I = I = I = I = I =
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#### 6. Complement of Test Method

#### 6.1.Test Jig

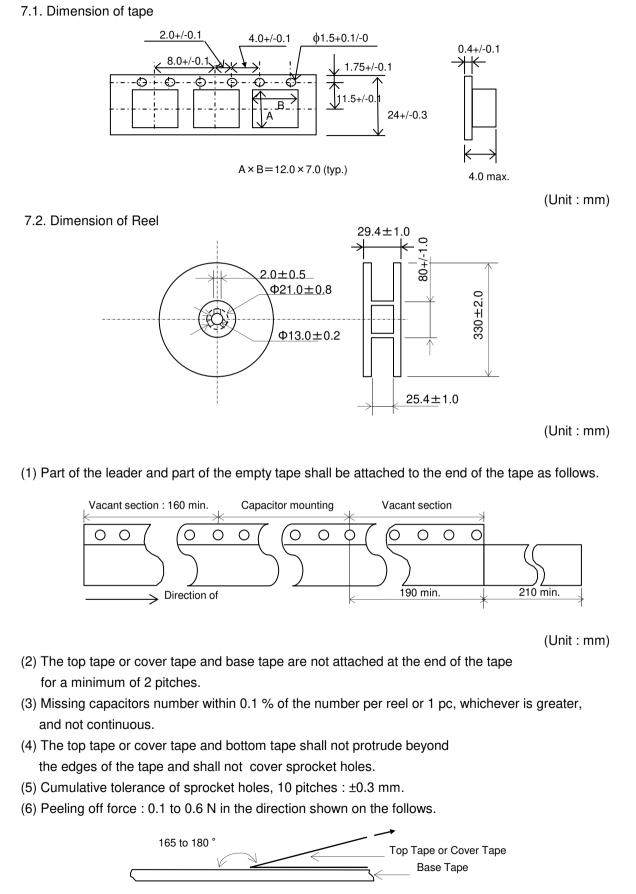
The test jig should be Jig A as described in "Specifications and Test methods". The specimen should be soldered by the conditions as described below. Soldering Method : Reflow soldering Solder : Sn-3.0Ag-0.5Cu

#### (1) Test Jig A



•Material : Glass Epoxy Board •Thickness : 1.6 mm •Thickness of copper foil : 0.035 mm

## 7. Packing



EKBCDK01